

1.6x1.6mm FULL-COLOR SURFACE MOUNT **LED**



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: APTF1616SEJ3ZGGVBDC

Hyper Red Green Blue

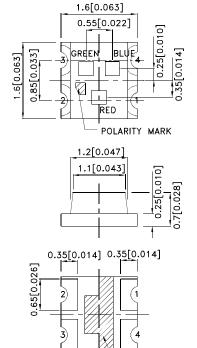
Features

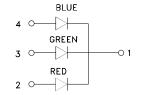
- 1.6mmX1.6mm SMT LED, 0.7mm thickness.
- Low power consumption.
- Can produce any color in visible spectrum, including white light.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

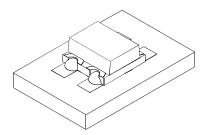
Descriptions

- The Hyper Red device is based on light emitting diode chip made from AlGaInP.
- The Green source color devices are made with InGaN Light Emitting Diode.
- The Blue source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

POLARITY MARK

SPEC NO: DSAM6939 **REV NO: V.3B** DATE: MAR/13/2015 PAGE: 1 OF 7 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: L.Q.Xie ERP: 1203013240

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APTF1616SEJ3ZGGVBDC	Hyper Red (AlGaInP)		200	360	120°
	Green (InGaN)	Water Clear	500	750	
	Blue (InGaN)		80	140	

Notes:

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity/ luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green Blue	640 520 465		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red Green Blue	625 525 470		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green Blue	25 35 22		nm	IF=20mA
С	Capacitance	Hyper Red Green Blue	27 100 100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green Blue	2.2 3.2 3.3	2.8 4 4	V	Ir=20mA
lr	Reverse Current	Hyper Red Green Blue		10 50 50	uA	VR=5V

Notes:

- 1.Wavelength: +/-1nm.
- 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

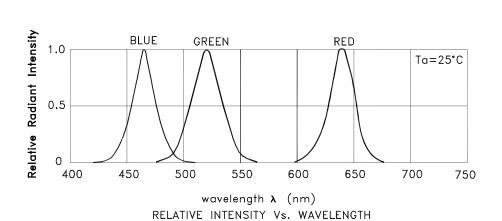
Parameter	Hyper Red	Green	Blue	Units		
Power dissipation	84	120	120	mW		
DC Forward Current	30	30	30	mA		
Peak Forward Current [1]	150	100	100	mA		
Reverse Voltage	5 V					
Operating Temperature	-40°C To +85°C					
Storage Temperature	-40°C To +85°C					

Notes:

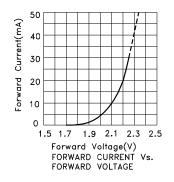
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

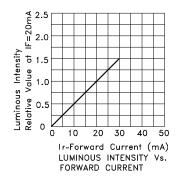
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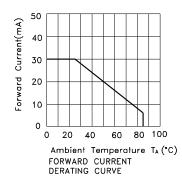
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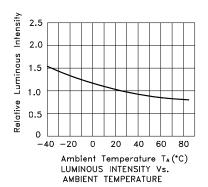


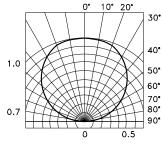
APTF1616SEJ3ZGGVBDC Hyper Red









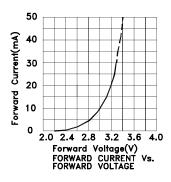


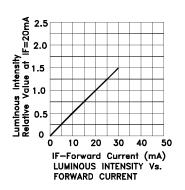
SPATIAL DISTRIBUTION

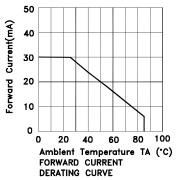
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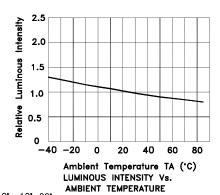
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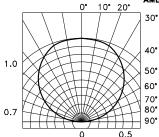
Green







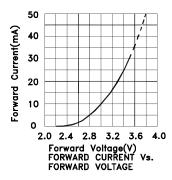


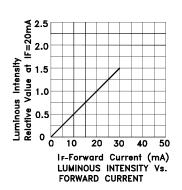


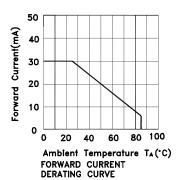
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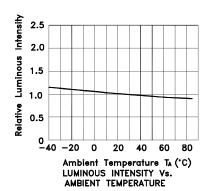
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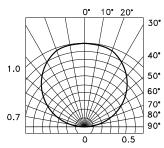
Blue











SPATIAL DISTRIBUTION

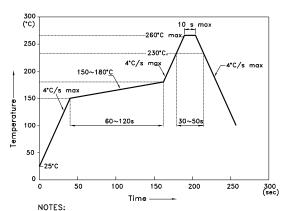
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

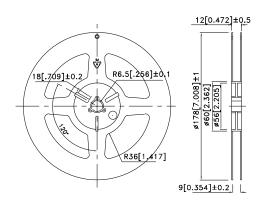
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

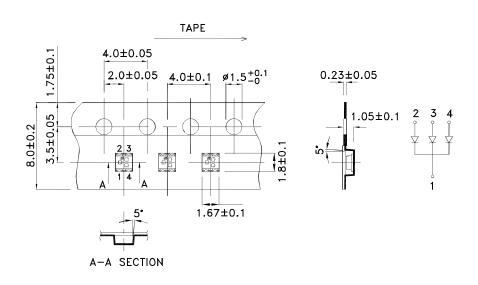
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

o. 0.9 2.6

Reel Dimension



Tape Dimensions (Units: mm)



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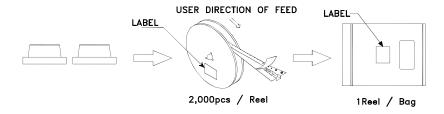
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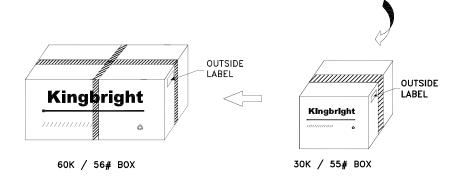
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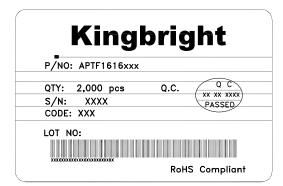


PACKING & LABEL SPECIFICATIONS

APTF1616SEJ3ZGGVBDC







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